

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHI-WEN ZHOU	05/15/2007
GUO CHEN	05/15/2007
PENG LIU	05/15/2007
CHUN-CHI CHEN	05/15/2007
RECEIVING PARTY DATA	
Name:	Foxconn Technology Co., Ltd.
Street Address:	3-2,CHUNG SHAN ROAD
City:	Tu-Cheng,Taipei Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11752902
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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- | | | | |
|----|-----------------------------|---------------|---|
| 1. | <u>Shi-Wen Zhou</u> | , residing at | <u>Shenzhen, Guangdong, China</u> |
| 2. | <u>Guo Chen</u> | , residing at | <u>Shenzhen, Guangdong, China</u> |
| 3. | <u>Peng Liu</u> | , residing at | <u>Shenzhen, Guangdong, China</u> |
| 4. | <u>Chun-Chi Chen</u> | , residing at | <u>Tu-Cheng, Taipei, Taiwan</u> |
| 5. | <u> </u> | , residing at | <u> </u> |
| 6. | <u> </u> | , residing at | <u> </u> |
| 7. | <u> </u> | , residing at | <u> </u> |
| 8. | <u> </u> | , residing at | <u> </u> |

hereby sell(s), assign(s) and transfer(s) unto: Foxconn Technology Co.,Ltd, having a principal place of business at 3-2, Chung Shan Road, Tu-cheng City, Taipei Hsien, Taiwan, ROC hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as Heat Dissipation Device With A Heat Pipe for which the undersigned

[] previously executed --- Ser. No. and filing date of
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Shi-Wen Zhou</u> Shi-Wen Zhou	inventor	<u>May 15, 2007</u> Date	<u> </u> Witness
2.	<u>Guo Chen</u> Guo Chen	inventor	<u>May 15, 2007</u> Date	<u> </u> Witness
3.	<u>Peng Liu</u> Peng Liu	inventor	<u>May 15, 2007</u> Date	<u> </u> Witness
4.	<u>Chun-Chi Chen</u> Chun-Chi Chen	inventor	<u>May 15, 2007</u> Date	<u> </u> Witness
5.	<u> </u>	inventor	<u> </u> Date	<u> </u> Witness
6.	<u> </u>	inventor	<u> </u> Date	<u> </u> Witness
7.	<u> </u>	inventor	<u> </u> Date	<u> </u> Witness
8.	<u> </u>	inventor	<u> </u> Date	<u> </u> Witness